


















Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0,40mil	3,5
4		TOP	Copper	0,71mil	
5		Dielectric 1	ROGER 4350B	10,00mil	3,66
6		L2_GND	Copper	0,71mil	
7		Dielectric2	FR-4	3,94mil	4,5
8		L3_H	Copper	1,38mil	
9		Dielectric3	FR-4	3,94mil	4,5
10		L4_V	Copper	1,38mil	
11		Dielectric4	FR-4	3,94mil	4,5
12		L5	Copper	0,71mil	
13		Dielectric5	ROGER 4350B	10,00mil	3,66
14		BOTTOM	Copper	0,71mil	
15		Bottom Solder	Solder Resist	0,40mil	3,5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 38,20mil				